

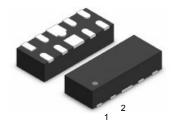
# CESD2510UC3V3USH

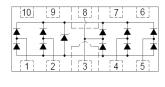
#### **CREATEK Microelectronics**

## Ultra Low Capacitance ESD TVS Array in DFN2510

#### **Features**

- 20Watts peak pulse power (Tp = 8/20µs)
- DFN2510 Package
- Unidirectional configurations
- Solid-state silicon-avalanche technology
- Low clamping voltage
- Low leakage current
- Low capacitance (0.2pF typical I/O to I/O)
- ESD Protection for high-speed data lines to: IEC 61000-4-2 ±8KV contact ±15KV air IEC 61000-4-4 (EFT) 40A (5/50ns) IEC 61000-4-5 (Lightning) 4A (8/20µs)





#### **Mechanical Data**

- Case: DFN2510 (plastic package).
  Lead free; RoHS compliant; Halogen free
- Molding Compound Flammability Rating: UL 94 V-0
- **Terminals:** High temperature soldering guaranteed: 260 °C/10 sec. at terminals

### **Applications**

- USB 3.1, USB 3.0, MHL
- HDMI 2.0, Display Port 1.3, eSATA
- Unified Display Interface (UDI)
- Digital Visual Interface (DVI)
- High speed serial interfaces

#### **Absolute Maximum Ratings**

Ratings at 25 °C, ambient temperature unless otherwise specified

Parameter	Symbol	Value	Unit
Peak Pulse Power (T <sub>P</sub> =8/20µs)	P <sub>PP</sub>	20	W
ESD contact/air discharge (IEC-61000-4-2)	V <sub>ESD</sub>	8/15	kV
Peak Pulse Current (T <sub>P</sub> = 8/20µs)	I <sub>PP</sub>	4.0	Α
Junction Temperature	TJ	-55 to +125	$^{\circ}$
Storage temperature	T <sub>STG</sub>	-55 to +150	$^{\circ}$

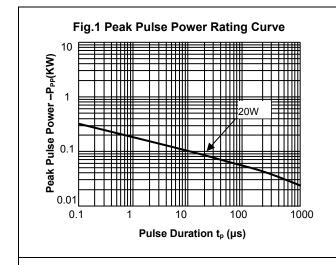
#### **Electrical Characteristics**

(T<sub>A</sub> = 25 °C unless otherwise specified)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Reverse stand-off Voltage	$V_{RWM}$				3.3	V
Holding Voltage	V <sub>H</sub>	Іт=Ін	2.5			V
Holding Current	I <sub>H</sub>		30			mA
Reverse Leakage Current	I <sub>R</sub>	V <sub>RWM</sub> =3.3V			0.5	uA
Clamping Voltage	V <sub>C</sub>	IPP=4A,Tp=8/20µs		5.0		V
Clamping Voltage(TLP)	Vc	I <sub>PP</sub> =16A, T <sub>P</sub> =100ns		6.0		V
Dynamic Resistance	$R_{dyn}$			0.2		Ω
Junction Capacitance	CJ	V <sub>R</sub> =0V,f=1MHz, I/O to I/O	•	0.20		pF
Junction Capacitance	CJ	V <sub>R</sub> =0V,f=1MHz, I/O to GND		0.40		pF

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# Typical Characteristics ( $T_{amb} = 25 \, ^{\circ}\text{C}$ unless otherwise specified)



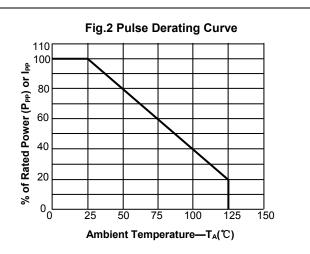
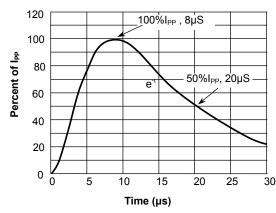
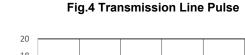


Fig.3 Pulse Waveform-8/20μs





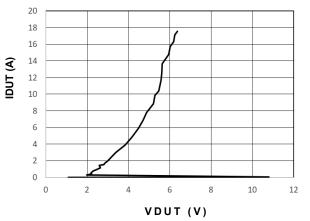


Fig.5 Eye Diagram - HDMI mask at 5Gbps per channel

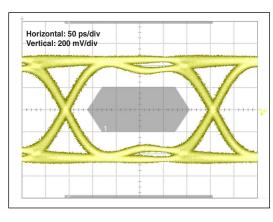
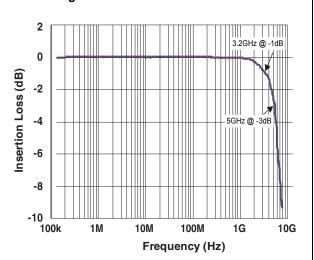


Fig.6 Insertion Loss S21 - I/O to GND



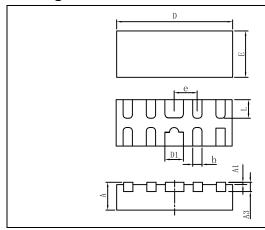
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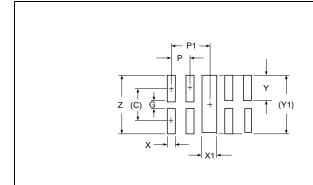
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### **Package Dimensions**



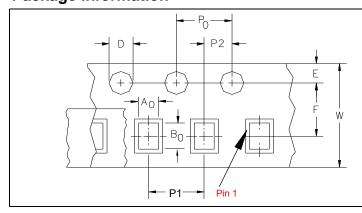
	Dimensions in millimeters			
Symbol	Min	Nom	Max	
Α	0.45	0.50	0.55	
A1	-	0.02	0.05	
A3	0.10	0.15	0.20	
D	2.45	2.50	2.55	
E	0.95	1.00	1.05	
D1	0.35	0.40	0.45	
b	0.15	0.20	0.25	
е	0.50BS			
L	0.35	0.40	0.45	

### **Pad Dimensions**



DIMENSIONS				
DIM	INCHES	MILLIMETERS		
С	.034	0.875		
G	.008	0.20		
Р	.020	0.50		
P1	.039	1.00		
Х	.010	0.25		
X1	.018	0.45		
Y	.027	0.675		
Y1	.061	1.55		
Z	.061	1.55		

# **Package Information**



Dimension	Typical	Unit
A0	1.15	
В0	2.65	
D	1.55	
P0	4.00	
P1	4.00	mm
P2	2.00	
Е	1.75	
F	3.50	
W	8.00	

# Ordering information

Order code	Marking	Package	Packaging option	Base quantity	Packaging specification
CESD2510UC3V3USH	33U	DFN2510	Tape and reel	3000pcs / reel	EIA STD RS-481

### **Revision history**

	Date	Revision	Changes
	5-Jul2021	3.0	Update

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